

DATA SHEET

COMPOUND FIELD EFFECT POWER TRANSISTOR

μ**ΡΑ1523Β**

P-CHANNEL POWER MOS FET ARRAY SWITCHING INDUSTRIAL USE

DESCRIPTION

The μ PA1523B is P-channel Power MOS FET Array that built in 4 circuits designed for solenoid, motor and lamp driver.

FEATURES

- Full Mold Package with 4 Circuits
- -4 V driving is possible
- Low On-state Resistance R_{DS(on)1} = 0.8 Ω MAX. (@V_{GS} = -10 V, I_D = -1 A) R_{DS(on)2} = 1.3 Ω MAX. (@V_{GS} = -4 V, I_D = -1 A)
- Low Input Capacitance Ciss = 190 pF TYP.

ORDERING INFORMATION

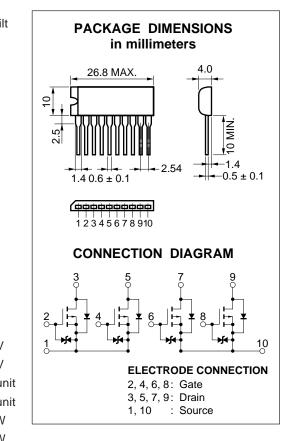
Type Number	Package
μPA1523BH	10 Pin SIP

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage (Vgs = 0)	Vdss	-60	V
Gate to Source Voltage (VDS = 0)	$V_{\text{GSS}(\text{AC})}$	∓20	V
Drain Current (DC)	D(DC)	∓2.0	A/uni
Drain Current (pulse)	ID(pulse) *	1 ∓8.0	A/uni
Total Power Dissipation	Pt1 *2	28	W
Total Power Dissipation	Рт2 * 3	3.5	W
Channel Temperature	Тсн	150	°C
Storage Temperature	Tstg	-55 to + 150	°C
Single Avalanche Current	las * 4	-2.0	А
Single Avalanche Energy	Eas *4	0.4	mJ

*1 PW \leq 10 μ s, Duty Cycle \leq 1%

***3** 4 Circuits, T_A = 25 °C



*2 4 Circuits, Tc = 25 °C *4 Starting TcH = 25 °C, VDD = -30 V, VGS = -20 V $\rightarrow 0$, RG = 25 Ω , L = 100 μ H

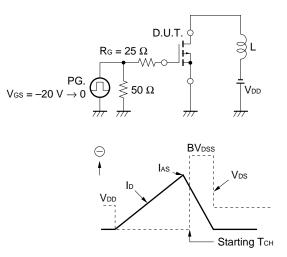
Build-in Gate Diodes are for protection from static electricity in handing. In case high voltage over V_{GSS} is applied, please append gate protection circuits.

The information in this document is subject to change without notice.

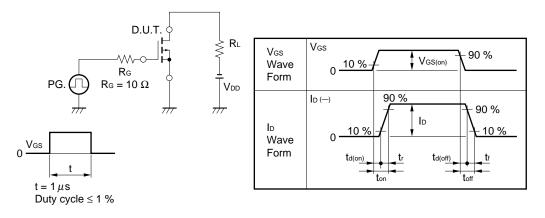
ELECTRICAL CHARACTERISTICS (T_A = 25 $^{\circ}$ C)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain Leakage Current	loss	$V_{DS} = -60 V, V_{GS} = 0$			-10	μA
Gate Leakage Current	lgss	$V_{GS} = \mp 20 \text{ V}, \text{ V}_{DS} = 0$			∓10	μA
Gate Cutoff Voltage	VGS(off)	$V_{DS} = -10 \text{ V}, \text{ ID} = -1.0 \text{ mA}$	-1.0		-2.0	V
Forward Transfer Admittance	Y _{fs}	$V_{DS} = -10 \text{ V}, \text{ ID} = -1.0 \text{ A}$	0.8			S
Drain to Source ON-Resistance	RDS(on)1	$V_{GS} = -10 \text{ V}, \text{ Id} = -1.0 \text{ A}$		0.5	0.8	Ω
Drain to Source ON-Resistance	RDS(on)2	$V_{GS} = -4.0 \text{ V}, \text{ Id} = -1.0 \text{ A}$		0.8	1.3	Ω
Input Capacitance	Ciss	$V_{DS} = -10 V$, $V_{GS} = 0$, f = 1.0 MHz		190		pF
Output Capacitance	Coss			115		pF
Reverse Transfer Capacitance	Crss			43		pF
Turn-on Delay Time	td(on)	$I_D = -1.0 \text{ A}, \text{ V}_{GS(on)} = -10 \text{ V},$		8		ns
Rise Time	tr	$V_{DD} \approx -30 \text{ V}, \text{ R}_{\text{L}} = 30 \Omega$		53		ns
Turn-off Delay Time	td(off)			400		ns
Fall Time	tr			230		ns
Total Gate Charge	QG	$V_{GS} = -10 \text{ V}, \text{ Id} = -2.0 \text{ A}, \text{ Vdd} = -48 \text{ V}$		10		nC
Gate to Source Charge	Qgs			1.1		nC
Gate to Drain Charge	Qgd			3.5		nC
Body Diode Forward Voltage	V _{F(S-D)}	IF = 2.0 A, VGS = 0		1.0		V
Reverse Recovery Time	trr	IF = 2.0 A, VGS = 0, di/dt = 50 A/µS		180		ns
Reverse Recovery Charge	Qrr			250		nC

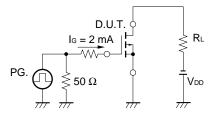
Test Circuit 1 Avalanche Capability



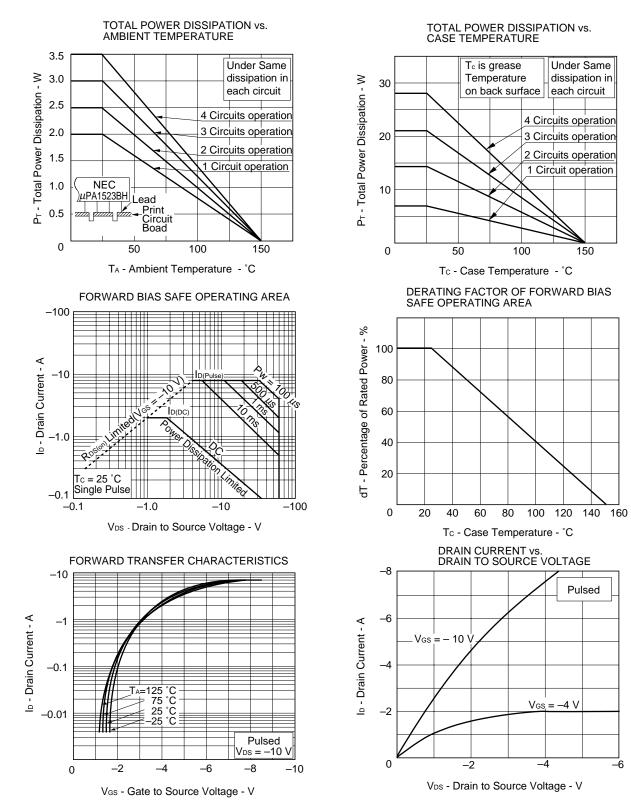
Test Circuit 2 Switching Time

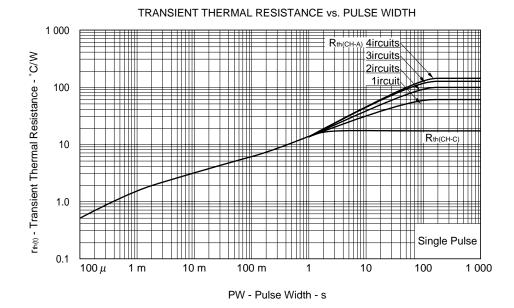


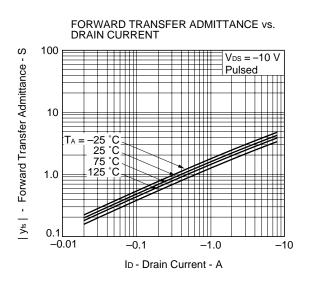
Test Circuit 3 Gate Charge

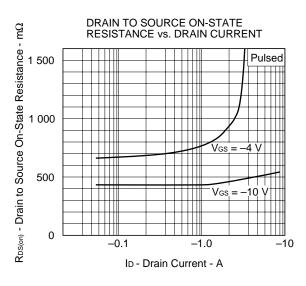




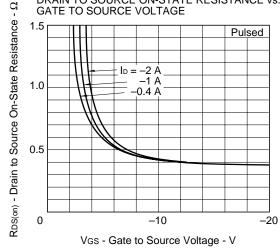




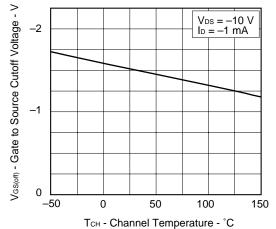




DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

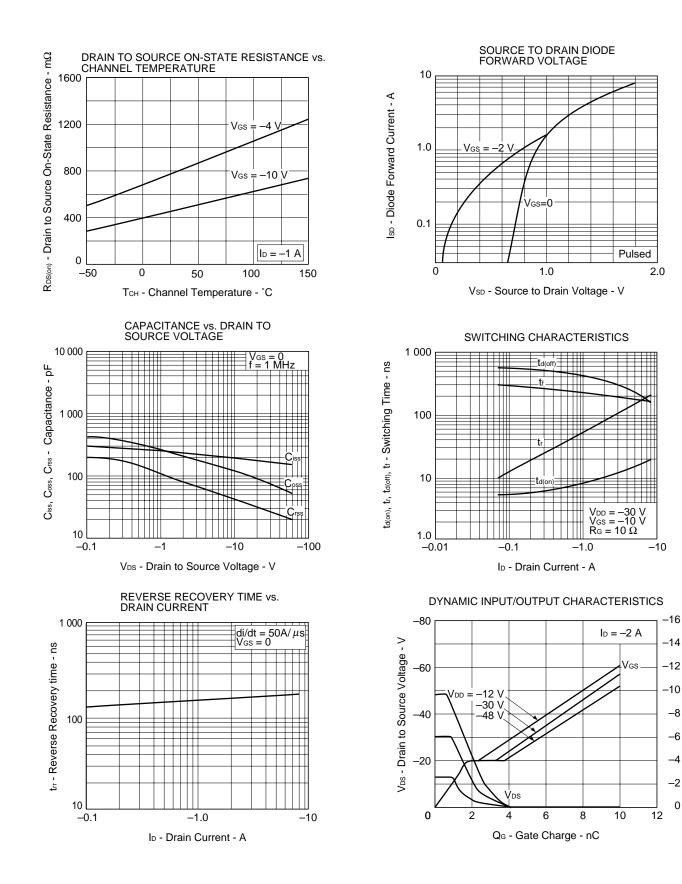


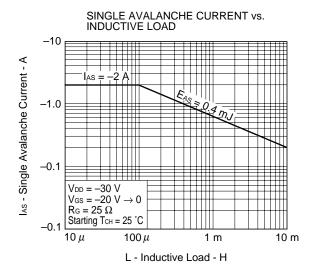
GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE

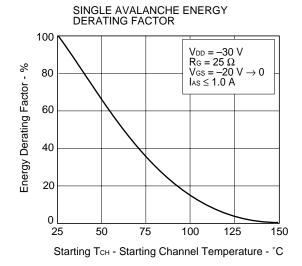


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Ves - Gate to Source Voltage







REFERENCE

Document Name	Document No.
NEC semiconductor for device reliability/quality control system	TEI-1202
Quality grade on NEC semiconductor devices	IEI-1209
Semiconductor device mounting technology manual	C10535E
Semiconductor device package manual	C10943X
Guide to quality assurance for semiconductor devices	MEI-1202
Semiconductor selection guide	X10679E
Power MOS FET features and application switching power supply	TEA-1034
Application circuits using Power MOS FET	TEA-1035
Safe operating area of Power MOS FET	TEA-1037

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Anti-radioactive design is not implemented in this product.

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